EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	47	wafer$4 same solder$4 same (reflect$4 or mirror$4) same electrod$4	US-PGPUB; USPAT	OR	OFF	2006/08/13 16:20
S2	0	(wafer$4 same microsctructu$4 same electrod$4) and 385/16-18.ccls.	US-PGPUB; USPAT	OR	OFF	2005/05/27 07:53
S3	2	(wafer$4 same microstructu$4 same electrod$4) and 385/16-18.ccls.	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:04
S4	118	(wafer$4 same microstructu$4 same electrod$4)	US-PGPUB; USPAT	OR	OFF	2005/05/27 07:55
S5	22	(wafer$4 same microstructu$4 same electrod$4 same (mirror$4 or reflect$4))	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:04
S6	2045	(wafer$4 same electrod$4 same (mirror$4 or reflect$4))	US-PGPUB; USPAT	OR	OFF	2005/05/27 12:58
S7	81	S6 and 385/16-18.ccls.	US-PGPUB; USPAT	OR	OFF	2006/08/13 14:04
S8	80	S7 not S5	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:05
S9	144719	"8" and solder$4	US-PGPUB; USPAT	OR	OFF	2005/05/27 12:57
S10	23	(wafer$4 same electrod$4 same (mirror$4 or reflect$4)) and solder$4 and 385/16-18.ccls.	US-PGPUB; USPAT	OR	OFF	2005/11/16 14:57
S11	793	wafer same solder$4 same ((flip$ or chip$4 or bond$4) and adhesive)	US-PGPUB; USPAT	OR	OFF	2005/11/16 14:41
S12	84	wafer same solder$4 same ((flip$ with chip$4 with bond$4) and adhesive)	US-PGPUB; USPAT	OR	OFF	2005/11/16 14:41
S13	58	wafer$4 same solder$4 same (reflect$4 or mirror$4) same electrod$4	US-PGPUB; USPAT	OR	OFF	2006/08/13 14:04
S14	36	(wafer$4 same microstructu$4 same electrod$4 same (mirror$4 or reflect$4))	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:09
S15	28	(wafer$4 same electrod$4 same (mirror$4 or reflect$4)) and solder$4 and 385/16-18.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:07
S16	106	wafer$4 same solder$4 same (reflect$4 or mirror$4) same electrod$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:04

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S17	3	(wafer$4 same microstructu$4 same electrod$4) and 385/16-18.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:04
S18	36	(wafer$4 same microstructu$4 same electrod$4 same (mirror$4 or reflect$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:05
S19	36	(wafer$4 same microstructu$4 same electrod$4 same (mirror$4 or reflect$4))	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:07
S20	2239	(wafer$4 same electrod$4 same (mirror$4 or reflect$4))	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:07
S21	90	S20 and 385/16-18.ccls.	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:07
S22	88	S21 not S19	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:07
S23	28	(wafer$4 same electrod$4 same (mirror$4 or reflect$4)) and solder$4 and 385/16-18.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:09
S24	36	(wafer$4 same microstructu$4 same electrod$4 same (mirror$4 or reflect$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:10
S25	812	(chip and bond$4 and (interconnect$4 connect$4) and electri$4 and terminal$4).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:11
S26	32	(chip and bond$4 and (interconnect$4 connect$4) and electri$4 and terminal$4 and (fiber$4 fibre$4)).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:12

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S27	4	(chip and bond$4 and (interconnect$4 connect$4) and electri$4 and terminal$4 and (fiber$4 fibre$4) and pattern).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:12
S28	0	lin.xa. and tina.xa. and lens and bulge	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:51
S29	42	lin.xa. and tina.xa. and lens	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:51
S30	251	solder$4 same wafer$4 same optic$3 same (electronic or electri$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/24 15:42
S31	356	wafer$4 same solder$4 same lower same upper	US-PGPUB; USPAT	OR	OFF	2006/03/28 14:46
S32	1	"6525864".pn.	US-PGPUB; USPAT	OR	OFF	2006/03/28 15:10
S33	1	"6781208".pn.	US-PGPUB; USPAT	OR	OFF	2006/03/28 15:11
S34	1	"6781239".pn.	US-PGPUB; USPAT	OR	OFF	2006/03/28 15:12
S35	1	"6946321".pn.	US-PGPUB; USPAT	OR	OFF	2006/03/28 15:13
S36	4	"5757536".pn. "20030122206".pn. "5096279".pn. "20020110312".pn.	US-PGPUB; USPAT	OR	OFF	2006/08/13 14:03
S37	64	wafer$4 same solder$4 same (reflect$4 or mirror$4) same electrod$4	US-PGPUB; USPAT	OR	ON	2006/08/13 14:04
S38	2516	(wafer$4 same electrod$4 same (mirror$4 or reflect$4))	US-PGPUB; USPAT	OR	OFF	2006/08/13 14:04
S39	98	S38 and 385/16-18.ccls.	US-PGPUB; USPAT	OR	ON	2006/08/13 14:04
S40	64	wafer$4 same solder$4 same (reflect$4 or mirror$4) same electrod$4	US-PGPUB; USPAT	OR	ON	2006/08/13 14:04
S41	3218	wafer$4 same (reflect$4 or mirror$4) same electrod$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/13 16:21

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S42	812	(wafer$4 same (reflect$4 or mirror$4) same electrod$4) and ((solder$4 contact$4) with wafer$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/13 16:22
S43	14	("5083857" | "5435876" | "5492596" | "5798557" | "5915168" | "6063696" | "6117705" | "6228684" | "6285064" | "6428650" | "6531328" | "6613607" | "6660562" | "6759723").PN. OR ("6908791").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/08/13 16:45